

2818



Attorney Docket No. 5649-958

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Lee et al.

Group Art Unit: 2818

Serial No.: 10/085,369

Examiner: Thao P. Le

Filed: February 28, 2002

Confirmation No.: 6590

For: METHODS OF FABRICATING READ ONLY MEMORY DEVICES
INCLUDING THERMALLY OXIDIZED TRANSISTOR SIDEWALLS;
AND DEVICES SO FABRICATED

Handwritten notes:
5/ Elect
C.
C. Stanley
5-9-03
1-5-03

April 29, 2003

Box NON-FEE AMENDMENT
Commissioner for Patents
Washington, DC 20231

AMENDMENT

Sir:

This Amendment is responsive to the Restriction Requirement of April 9, 2003

In the Title:

Please delete the title in all occurrences and substitute the following title therefor: --METHODS OF FABRICATING READ ONLY MEMORY DEVICES INCLUDING THERMALLY OXIDIZED TRANSISTOR SIDEWALLS--.

In the Claims:

Please cancel Claims 14-19 without prejudice to the filing of a divisional application.

REMARKS

In response to the Restriction Requirement of April 9, 2003, Applicants hereby elect Invention II, corresponding to Claims 1-13, drawn to a method of adhering copper thin film to a substrate. Applicants have canceled Invention I, corresponding to Claims 14-19, drawn to an integrated circuit having a copper interconnect. This cancellation is being made without prejudice to the filing of a divisional application for these claims.